

## Description

The ADNS-2030 is a low-power optical mouse sensor used to implement a non-mechanical tracking engine for computer mice. With a 3.3 V power supply and power-saving sleep functions, this sensor is particularly suited to cordless mouse applications.
It is based on optical navigation technology, which measures changes in position by optically acquiring sequential surface images (frames) and mathematically determining the direction and magnitude of movement.
The sensor is housed in a 16pin staggered dual inline package (DIP) that is designed for use with the HDNS-2100 Lens and HDNS-2200 Clip and HLMP-ED80-xx000 (639 nm LED illuminator source). There are no moving parts, and precision optical alignment is not required, facilitating high volume assembly.

The output format is two channel quadrature ( X and Y direction) which emulates encoder photo-transistors. The current X and Y information

## Agilent ADNS-2030 Low Power Optical Mouse Sensor

 Data Sheet
are also available in registers accessed via a serial port.

Default resolution is specified as 400 counts per inch, with rates of motion up to 14 inches per second. Resolution can also be programmed to 800 cpi.

The part is programmed via a two wire serial port, through registers.

## Theory of Operation

The ADNS-2030 is based on Optical Navigation Technology. It contains an Image Acquisition System (IAS), a Digital Signal Processor (DSP) and a two channel quadrature output, and a two wire serial port.
The IAS acquires microscopic surface images via the lens and illumination system provided by the HDNS-2100, 2200, and HLMP-ED80-xx000. These images are processed by the DSP to determine the direction and distance of motion. The DSP generates the $\Delta x$ and $\Delta y$ relative displacement values that are converted to two channel quadrature signals.

## Features

- Precise optical navigation technology
- No mechanical moving parts
- Complete 2D motion sensor
- Serial interface and/or quadrature interface
- Smooth surface navigation
- Programmable frame speed up to 2300 frames per sec (fps)
- Accurate motion up to 14 ips
- 800 cpi resolution
- High reliability
- High speed motion detector
- Wave solderable
- Single 3.3 volt power supply
- Shutdown pin for USB suspend mode operation
- Power conservation mode during times of no movement
- On chip LED drive with regulated current
- Serial port registers
- Programming
- Data transfer
- 16-pin staggered dual inline package (DIP)


## Applications

- Cordless optical mice
- Mice for desktop PCs, workstations, and portable PCs
- Trackballs
- Integrated input devices

Pinout of ADNS-2030 Optical Mouse Sensor

| Pin Number | Pin | Description |
| :--- | :--- | :--- |
| $\mathbf{1}$ | SCLK | Serial port clock (input) |
| 2 | XA | XA quadrature output |
| 3 | XB | XB quadrature output |
| 4 | YB | YB quadrature output |
| 5 | YA | YA quadrature output |
| 6 | XY_LED | LED control |
| 7 | REFA | Internal reference |
| $\mathbf{8}$ | REFB | Internal reference |
| 9 | OSC_IN | Oscillator input |
| $\mathbf{1 0}$ | GND | System ground |
| 11 | OSC_OUT | Oscillator output |
| $\mathbf{1 2}$ | GND | System Ground |
| $\mathbf{1 3}$ | VDD | 3.3 volt power supply |
| 14 | R_BIN | LED current bin resistor |
| $\mathbf{1 5}$ | PD | Power Down Pin, active high |
| $\mathbf{1 6}$ | SDIO | Serial data (input and output) |



Figure 1. Top view.


Figure 2. Package outline drawing of ADNS-2030 optical mouse sensor.

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

## Overview of Optical Mouse Sensor

 Assembly
## 2D Assembly Drawing of ADNS-2030

Figures 3 and 4, shown with HDNS-2100, HDNS-2200 and HLMP-ED80-xx000.

Agilent Technologies provides an IGES file drawing describing the base plate molding features for lens and PCB alignment
These components interlock as they are mounted onto defined features on the base plate.
The ADNS-2030 sensor is designed for mounting on a through hole PCB, looking down. There is an aperture stop and features on the package that align to the lens. The HDNS-2100 lens provides optics for the imaging of the surface as well as illumination of the surface at the optimum angle. Features on the lens align it to the sensor, base plate, and clip with the LED. The lens also has a large round flange to provide a long creepage path for any ESD events that occur at the opening of the base plate.
The HDNS-2200 clip holds the LED in relation to the lens. The LED must be inserted into the clip and the LED's leads formed prior to loading on the PCB. The clip interlocks the sensor to the lens, and through the lens to the alignment features on the base plate.
The HLMP-ED80-xx000 LED is recommended for illumination. If used with the bin table, sufficient illumination can be guaranteed.


Figure 3. Recommended PCB mechanical cutouts and spacing (top view).


Figure 4. 2D assembly drawing of ADNS-2030 (top and side view).


Figure 5. Exploded view drawing.


Figure 6. Block diagram of ADNS-2030 optical mouse sensor.

## PCB Assembly Considerations

1. Insert the sensor and all other electrical components into PCB.
2. Bend the LED leads $90^{\circ}$ and then insert the LED into the assembly clip until the snap feature locks the LED base.
3. Insert the LED/clip assembly into PCB.
4. Wave Solder the entire assembly in a no-wash solder process utilizing solder fixture. The solder fixture is needed to protect the sensor during the solder process. The fixture should be designed to expose the sensor leads to solder while shielding the optical aperture from direct solder contact. The solder fixture is also used to set the reference height of the sensor to the PCB top during wave soldering (Note: DO NOT remove the kapton tape during wave soldering).
5. Place the lens onto the base plate.
6. Remove the protective kapton tape from optical aperture of the sensor. Care must be taken to keep contaminants from entering the aperture. It is recommended not to place the PCB facing up during the entire mouse assembly process. The PCB should be held vertically during the kapton removal process.
7. Insert PCB assembly over the lens onto the base plate aligning post. The sensor aperture ring should selfalign to the lens.
8. The optical position reference for the PCB is set by the base plate and lens. Note that the PCB motion due to button presses must be minimized to maintain optical alignment.
9. Install mouse top case. There must be a feature in the top case to press down onto the clip to ensure all components are interlocked to the correct vertical height.

## Design Considerations for Improving ESD Performance

The flange on the lens has been designed to increase the creepage and clearance distance for electrostatic discharge. The table below shows typical values assuming base plate construction per the Agilent supplied IGES file and HDNS-2100 lens flange.

| Typical Distance | Millimeters |
| :--- | :--- |
| Creepage | 16.0 |
| Clearance | 2.1 |

For improved ESD performance, the lens flange can be sealed (i.e. glued) to the base plate. Note that the lens material is polycarbonate and therefore, cyanoacrylate based adhesives or other adhesives that may damage the lens should NOT be used.


Figure 7. PCB assembly.


## Notes on Bypass Capacitors

- Caps for pins 7, 8 and 12 , 13 MUST have trace lengths LESS than 5 mm .
- The $0.1 \mu \mathrm{~F}$ caps must be ceramic.
- Caps should have less than 5 nH of self inductance.
- Caps should have less than $0.2 \Omega$ of ESR.
- Surface mount parts are recommended.


## Regulatory Requirements

- Passes FCC B and worldwide analogous emission limits when assembled into a mouse with unshielded cable and following Agilent recommendations.
- Passes EN61000-4-4/IEC8014 EFT tests when assembled into a mouse with unshielded cable and following Agilent recommendations.
- UL flammability level UL94 V0.

Absolute Maximum Ratings

| Parameter | Symbol | Minimum | Maximum | Units | Notes |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Storage Temperature | $\mathrm{T}_{\mathrm{S}}$ | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |  |
| Operating Temperature | $\mathrm{T}_{\mathrm{A}}$ | -15 | 55 | ${ }^{\circ} \mathrm{C}$ |  |
| Lead Solder Temp |  |  | 260 | ${ }^{\circ} \mathrm{C}$ | For 10 seconds, 1.6 mm below seating plane |
| Supply Voltage | $\mathrm{V}_{\mathrm{DD}}$ | -0.5 | 3.6 | V |  |
| ESD |  |  | 2 | KV | All pins, human body model MIL 883 Method 3015 |
| Input Voltage | $\mathrm{V}_{\mathrm{IN}}$ | -0.5 | $\mathrm{~V}_{\mathrm{DD}}+0.5$ | V | All I/0 pins |

## Recommended Operating Conditions

| Parameter | Symbol | Minimum | Typical | Maximum | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Temperature | $\mathrm{T}_{\text {A }}$ | 0 |  | 40 | ${ }^{\circ} \mathrm{C}$ |  |
| Power Supply Voltage | $V_{\text {DD }}$ | 3.0 | 3.3 | 3.6 | Volts |  |
| Power Supply Rise Time | $\mathrm{V}_{\text {RT }}$ |  |  | 100 | ms |  |
| Supply Noise | $\mathrm{V}_{\mathrm{N}}$ |  |  | 30 | mV | Peak to peak @ 27 MHz bandwidth |
| Clock Frequency | $\mathrm{f}_{\text {CLK }}$ | 17.4 | 18.0 | 18.7 | MHz | Set by ceramic resonator |
| Serial Port Clock Frequency | SCLK |  |  | $\mathrm{f}_{\mathrm{CLK}} / 4$ | MHz |  |
| Resonator Impedance | $\mathrm{X}_{\text {RES }}$ |  |  | 55 | y |  |
| Distance from Lens Reference Plane to Surface | Z | 2.3 | 2.4 | 2.5 | mm | Results in $\mathbf{\pm 0 . 2 \mathrm { mm } \text { DOF }}$ (See Figure 9.) |
| Speed | S | 0 |  | 14 | in/sec | @ frame rate $=1500 \mathrm{fps}$ |
| Acceleration | A |  |  | 0.15 | g | $@$ frame rate $=1500 \mathrm{fps}$ |
| Light Level onto IC | IRR $_{\text {INC }}$ | $\begin{aligned} & 80 \\ & 100 \end{aligned}$ |  | $\begin{aligned} & 25,000 \\ & 30,000 \end{aligned}$ | $\mathrm{mW} / \mathrm{m}^{2}$ | $\begin{aligned} & \lambda=639 \mathrm{~nm} \\ & \lambda=875 \mathrm{~nm} \end{aligned}$ |
| SDIO Read Hold Time | $\mathrm{t}_{\text {HOLD }}$ | 100 |  |  | $\mu \mathrm{s}$ | Hold time for valid data (Refer to Figure 27.) |
| SDIO Serial Write-write Time | $\mathbf{t}_{\text {sww }}$ | 100 |  |  | $\mu \mathrm{s}$ | Time between two write commands (Refer to Figure 30.) |
| SDIO Serial Write-read Time | $\mathbf{t s W R}$ | 100 |  |  | $\mu \mathrm{s}$ | Time between write and read operation (Refer to Figure 31.) |
| SDIO Serial Read-write Time | $\mathrm{t}_{\text {SRW }}$ | 120 |  |  | ns | Time between read and write operation (Refer to Figure 32.) |
| SDIO Serial Read-read Time ${ }^{\text {- }}$ | $\mathbf{t}_{\text {SRR }}$ | $120 \cdots$ |  |  | ns | Time between two read commands (Refer to Figure 32.) |
| Data Delay after PD $\downarrow$ | $\mathbf{t}_{\text {compute }}$ | $3.2 \cdots$ |  |  | ms | After $\boldsymbol{t}_{\text {COMPUTE, }}$ all registers contain data from first image after PD $\downarrow$. Note that an additional 75 frames for AGC stabilization may be required if mouse movement occurred while PD was high. (Refer to Figure 11.) |
| SDIO Write Setup Time | $\mathbf{t s e t u p ~}$ | 60 |  |  | ns | Data valid time before the rising of SCLK (Refer to Figure 25.) |
| PD Pulse Width <br> (to power down the chip) | $\mathrm{t}_{\text {PDW }}$ | 700 |  |  | $\mu \mathrm{s}$ | Pulse width to initiate the power down cycle @1500 fps (Refer to Figure 13.) |
| PD Pulse Width (to reset the serial port) | $t_{\text {PD }}$ | 100 |  |  | $\mu \mathrm{s}$ | Pulse width to reset the serial port @1500 fps (but may also initiate a power down cycle) (Refer to Figure 11.) |
| Frame Rate | FR |  | 1500 |  | frames/s | See Frame_Period register section |
| Bin Resistor | R1 | 15K | 15K | 37K | $\Omega$ | Refer to Figure 8 |



Figure 9. Distance from lens reference plane to surface.

## AC Electrical Specifications

Electrical Characteristics over recommended operating conditions. Typical values at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, 18 \mathrm{MHz}, 1500 \mathrm{fps}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Notes |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Power Down |  |  |  |  |  |  |

## DC Electrical Specifications

Electrical Characteristics over recommended operating conditions. Typical values at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, 18 \mathrm{MHz}$.

| Parameter | Symbol | Min. | Тур. | Max. | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC Supply Current (mouse moving) | $\mathrm{I}_{\text {DD AVG }}$ |  | 13 | 23 | mA | No load on XA, XB, YA, YB, SCLK, SDIO. Excluding LED current. |
| Peak Supply Current (mouse moving) | $\mathrm{I}_{\text {DD PEAK }}$ |  | 18 |  | mA | No load on XA, XB, YA, YB, SCLK, SDIO. Excluding LED current. |
| DC Supply Current (mouse not moving) | $\mathrm{I}_{\mathrm{DD}}$ |  | 10 | 23 | mA | No load on XA, XB, YA, YB, SCLK, SDIO. Excluding LED current. |
| DC Supply Current (Power Down) | $\mathrm{I}_{\text {DDPD }}$ |  | 4 | 30 | $\mu \mathrm{A}$ | PD $=\mathrm{V}_{\mathrm{DD}}, \mathrm{SCLK}, \mathrm{SDIO}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{DD}}$ |
| SCLK, SDIO, PD |  |  |  |  |  |  |
| Input Low Voltage | $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |  |
| Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 0.65 * $\mathrm{V}_{\text {D }}$ |  |  | V |  |
| Output Low Voltage | $\mathrm{V}_{0 \mathrm{~L}}$ |  |  | 0.45 | V | @ $\mathrm{OLL}^{\text {= }} \mathbf{2} \mathrm{mA}$ (SDIO only) |
| Output High Voltage | $\mathrm{V}_{\text {OH }}$ | 0.6 * $\mathrm{V}_{\text {D }}$ |  |  | V | $@^{\text {OH }}$ = 2 mA (SDIO only) |
| Output Low Voltage (XA, XB, YA, YB) | $\mathrm{V}_{0 \mathrm{~L}}$ |  |  | 0.6 | V | $@_{0 L}=0.5 \mathrm{~mA}$ |
| Output High Voltage (XA, XB, YA, YB) | $\mathrm{V}_{\mathrm{OH}}$ | 0.6 * $\mathrm{V}_{\text {D }}$ |  |  | V | $@_{0 \mathrm{H}}=0.5 \mathrm{~mA}$ |
| Output Low Voltage (XY_LED) | $\mathrm{V}_{\mathbf{0 L}}$ |  |  | 0.5 | V | Refer to Figure 10. |
| XY LED Current | $\mathrm{I}_{\text {LED }}$ | $\begin{aligned} & \text { Typ -20\% } \\ & \text { Typ -15\% } \end{aligned}$ | $\begin{aligned} & \text { 614/R1 } \\ & 614 / R 1 \end{aligned}$ | $\begin{aligned} & \text { Typ +20\% } \\ & \text { Typ }+15 \% \end{aligned}$ | $\begin{aligned} & \mathbf{A} \\ & \mathbf{A} \end{aligned}$ | Recommended operating conditions $@ 25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ <br> (Refer to Figure 10 and table below). |
| XY LED Current (Fault Mode) | $I_{\text {Led }}$ |  |  | 1000 | $\mu \mathrm{A}$ | R1 < 200 2 |
| Powerup XY LED Current | $\mathrm{I}_{\text {Led }}$ |  |  | 500 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DD}}<2.5 \mathrm{~V}$ |



Figure 10. Typical I-V characteristic of ADNS-2030 XY_LED pin.

Typical LED Current Table

| R1 value | $\mathbf{k} \Omega$ | 15 | 18 | 22 | 27 | 33 | 37 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LED current (Typical) | mA | 41 | 34 | 28 | 23 | 19 | 17 |

## PD Pin Timing



Figure 12. PD timing - sleep mode.

(Power Down)
Figure 13. PD minimum pulse width.


Figure 14. Detail of PD falling edge timing.

## Quadrature Mode Timing

The output waveforms emulate the output from encoders. With the resolution set to 400 cpi , from one to five quadrature states can exist within one frame time. The minimum state time is $133 \mu \mathrm{~s}$. If the resolution is 800 cpi , then up to ten quadrature states can exist
within a frame time. If the motion within a frame is greater than these values, the extra motion will be reported in the next frame. The following diagrams (see Figures 15, 16 and 17) show the timing for positive $X$ motion, to the right, or positive Y motion, up. If a
power down via the PD pin occurs during a transfer, the transfer will resume after PD is de-asserted. The timing for that quadrature state will be increased by the length of the PD time.


Figure 15. Quadrature states per frame ( 400 cpi mode).


Figure 16. Quadrature states per frame ( 800 cpi mode).


Figure 17. Quadrature states per frame ( 800 cpi mode).

## Quadrature State Machine

The following state machine shows the states of the quadrature pins. The two things to note are that while
the PD pin is asserted, the state machine is halted. Once PD is de-asserted, the state machine picks up from where it left off. State 0 is entered after a power up reset.


| STATE | X and Y <br> OUTPUT |  |
| :---: | :---: | ---: |
|  | A | B |
| $\mathbf{0}$ | $\mathbf{0}$ | $\mathbf{0}$ |
| 1 | 0 | 1 |
| 2 | 1 | 0 |
| 3 | 1 | 1 |

Figure 18. Quadrature state machine.

## Quadrature Output Waveform

The two channel quadrature outputs are 3.3 volt CMOS outputs. The $\Delta x$ count is used to generate the XA and XB signals, and $\Delta y$ count is used for the YA and YB signals.


Figure 19. Quadrature output waveform.

## Typical Performance Characteristics

Performance characteristics over recommended operating conditions. Typical values at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, 18 \mathrm{MHz}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Notes |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Path Error (Deviation) <br> expressed | $P_{\text {Error }}$ |  | 0.5 | $\%$ | Path Error (Deviation) is the error from the ideal cursor path. It is <br> as a percentage of total travel and is measured over standard surfaces. |  |

The following graphs (Figs 2023) are the typical performance of the ADNS-2030 sensor, assembled as shown in the 2D
assembly drawing with the HDNS-2100 Lens/Prism, the HDNS-2200 clip, and the HLMP-ED80-xx000 LED (See Figure 5)


Figure 20. Typical Resolution vs. Height, Z. (Comparative Surfaces)


Figure 22. Typical Resolution vs. Height, Z. (Manila folder and LED variation) ${ }^{[2,3]}$


Figure 21. Wavelength Responsivity ${ }^{[1]}$.


Figure 23. Typical Resolution vs. Height, Z. (Black copy and LED variation) ${ }^{[2,3]}$

Notes:

1. The ADNS-2030 is designed for optimal performance when used with the HLMP-ED80-xx000 (Red LED 639 nm ). For use with other LED colors (ie. blue, green), please consult factory. When using alternate LED's there may also be performance degradation and additional eye safety consideration.
2. $Z=$ Distance from Lens Reference Plane to Surface.
3. $\mathrm{DOF}=$ Depth of Field

## Synchronous Serial Port

The synchronous serial port is used to set and read parameters in the ADNS-2030, and can be used to read out the motion information instead of the quadrature data pins.
The port is a two wire, half duplex port. The host microcontroller always initiates communication; the ADNS-2030 never initiates data transfers.

SCLK: The serial port clock. It is always generated by the master (the microcontroller).
SDIO: The data line.
PD: A third line is sometimes involved. PD (Power Down) is usually used to place the ADNS-2030 in a low power mode. PD can also be used to force re-synchronization between the microcontroller and the ADNS-2030 in case of an error.

## Write Operation

A write operation, which means that data is going from the microcontroller to the ADNS-2030, is always initiated by the microcontroller and consists of two bytes. The first byte contains the address (seven bits) and has a"1" as its MSB to indicate data direction. The second byte contains the data. The transfer is synchronized by SCLK. The microcontroller changes SDIO on falling edges of SCLK. The ADNS-2030 reads SDIO on rising edges of SCLK.


Figure 24 . Write operation.


Figure 25. SDIO setup and hold times SCLK pulse width.

## Read Operation

A read operation, which means that data is going from the ADNS-2030 to the microcontroller, is always initiated by the micro-controller and consists of two bytes. The first byte contains the address, is written by the micro-controller, and has a "0" as its MSB to
indicate data direction. The second byte contains the data and is driven by the ADNS-2030. The transfer is synchronized by SCLK. SDIO is changed on falling edges of SCLK and read on every rising edge of SCLK. The micro-controller must go to a high Z state after the last address data bit. The ADNS-2030
will go to the high Z state after the last data bit. (see detail "B" in Figure 28). One other thing to note during a read operation is that SCLK will need to be delayed after the last address data bit to ensure that the ADNS-2030 has at least $100 \mu \mathrm{~s}$ to prepare the requested data. This is shown in the timing diagrams below.


Figure 26. Read operation.


Figure 27. Microcontroller to ADNS-2030 SDIO handoff.

Detail "B"

ADNS-2030 to
Microcontroller SDIO handoff


Figure 28. ADNS-2030 to microcontroller SDIO handoff.

NOTE: The 120 ns high state of SCLK is the minimum data hold time of the ADNS-2030. Since the falling edge of SCLK is actually the start of the next read or write command, the

ADNS-2030 will hold the state of $\mathrm{D}_{0}$ on the SDIO line until the falling edge of SCLK. In both write and read operations, SCLK is driven by the microcontroller.

Serial port communications is not allowed while PD (Power Down) is high. See "Error Detection and Recovery" regarding re-synchronizing via PD.

## Forcing the SDIO Line to the Hi-Z State

There are times when the SDIO line from the ADNS-2030 should be in the Hi-Z state. If the microprocessor has completed a write to the ADNS-2030, the SDIO line is Hi-Z, since the SDIO pin is still configured as an input. However, if the last operation from the microprocessor was a read, the ADNS-2030 will hold the D0 state on SDIO until a falling edge of SCLK.

To place the SDIO pin into the $\mathrm{Hi}-\mathrm{Z}$ state, first raise the PD pin for $100 \mu \mathrm{~s}(\mathrm{~min})$. The PD
pin can stay high, with the ADNS-2030 in the shutdown state, or the PD pin can be lowered, returning the ADNS2030 to normal operation. In either case, the SDIO line will now be in the $\mathrm{Hi}-\mathrm{Z}$ state.


Figure 29. SDIO Hi-Z state and timing.


Figure 30. Timing between two write commands.


Figure 31. Timing between write and read commands.


Figure 32. Timing between read and either write or subsequent read commands.

The falling edge of SCLK for the first address bit of either the read or write command must be at least 120 ns after the last SCLK rising edge of the last data bit of the previous read operation.


Figure 33. Timing between SCLK and PD rising edge.

## Error Detection and Recovery

1. The ADNS-2030 and the microcontroller might get out of synchronization due to ESD events, power supply droops or microcontroller firmware flaws. In such a case the microcontroller should raise PD for $100 \mu \mathrm{~s}$. The ADNS-2030 will reset the serial port but will not reset the registers, and be prepared for the beginning of a new transmission.
2. The ADNS-2030 has a transaction timer for the serial port. If the $16^{\text {th }}$ SCLK rising edge is spaced more than approximately 0.9 seconds from the first SCLK edge of the current transaction, the serial port will reset.
3. Invalid addresses:

Writing to an invalid address will have no effect. Reading from an invalid address will return all zeros.
4. Collision detection on SDIO:

The only time that the ADNS-2030 drives the SDIO line is during a READ operation. To avoid data collisions, the microcontroller should relinquish SDIO before the falling edge of SCLK after the last address bit. The ADNS-2030 begins to drive SDIO after the next rising edge of SCLK. The ADNS2030 relinquishes SDIO within 120 ns of the falling SCLK edge after the last data bit. The microcontroller can begin driving SDIO any time after that. In order to maintain low power consumption in normal operation or when the PD pin is pulled high, the micro-controller should not leave SDIO floating until the next transmission (although that will not cause any communication difficulties).
5. In case of synchronization failure, both the ADNS-2030 and the microcontroller may drive SDIO. The ADNS-2030 can withstand 30 mA of short circuit current and will withstand infinite duration short circuit conditions.
6. Termination of a transmission by the microcontroller may sometimes be required (for example, due to a USB suspend interrupt during a read operation). To accomplish this the microcontroller should raise PD. The ADNS-2030 will not write to any register and will reset the serial port (but nothing else) and be prepared for the beginning of future transmissions after PD goes low.
7. The microcontroller can verify success of write operations by issuing a read command to the same address and comparing written data to read data.
8. The microcontroller can verify the synchronization of the serial port by periodically reading the product ID register.

## Notes on Power up and the Serial Port

The sequence in which $V_{D D}$, PD, SCLK and SDIO are set during powerup can affect the operation of the serial port. The diagram below shows what can happen shortly after powerup when the microprocessor tries to read data from the serial port.
This diagram shows the $V_{D D}$ rising to valid levels, at some point the microcontroller starts its program, sets the SCLK and SDIO lines to be outputs, and sets them high. It then waits to ensure that the ADNS-2030 has powered up and is ready to communicate. The microproces-
sor then tries to read from location 0x00, Product_ID, and is expecting a value of $0 x 03$. If it receives this value, it then knows that the communication to the ADNS-2030 is operational.
The problem occurs if the ADNS-2030 powers up before the microprocessor sets the SCLK and SDIO lines to be outputs and high. The ADNS2030 sees the raising of the SCLK as a valid rising edge, and clocks in the state of the SDIO as the first bit of the address (sets either a read or a write depending upon the state).

In the case of SDIO low, then a read operation has started. When the microprocessor begins to actually send the address, the ADNS-2030 already has the first bit of an address. When the $7^{\text {th }}$ bit is sent by the micro, the ADNS-2030 has a valid address, and drives the SDIO line high within 120 ns (see detail "A" in Figure 26 and Figure 27). This results in a bus fight for SDIO. Since the address is wrong, the data sent back will be incorrect.

In the case of SDIO high, a write operation is started. The address and data are out of synchronization, and the wrong data will be written to the wrong address.


Figure 34. Power up serial port sequence.

## Two Solutions

There are two different ways to solve the problem: (1) waiting for the serial port watchdog timer to time out, or (2) using the PD line to reset the serial port.

## 1. Serial port watchdog timer timeout (Refer to Figure 35.)

If the microprocessor waits at least $\mathrm{t}_{\mathrm{SPTT}}$ from $\mathrm{V}_{\mathrm{DD}}$ valid, it will ensure that the ADNS-2030 has powered up and the watchdog timer has timed out. This assumes that the microprocessor and the ADNS-2030 share the
same power supply. If not, then the microprocessor must wait $\mathrm{t}_{\text {SPTT }}$ from ADNS-2030 $\mathrm{V}_{\mathrm{DD}}$ valid. Then when the SCLK toggles for the address, the ADNS-2030 will be in sync with the microprocessor.

## 2. PD Sync (Refer to Figure 36.)

The PD line can be used to resync the serial port. If the microprocessor waits for 4 ms from $\mathrm{V}_{\mathrm{DD}}$ valid, and then outputs a valid PD pulse (Refer to Figure 14), then the serial port will be ready for data.

## Resync Note

If the microprocessor and the ADNS-2030 get out of sync, then the data either written or read from the registers will be incorrect. An easy way to solve this is to output a PD pulse to resync the parts after an incorrect read.


Figure 35. Power up serial port watchdog timer sequence.


Figure 36. Power up serial port PD sync sequence.

## Registers

The ADNS-2030 can be programmed through registers, via the serial port, and configuration and motion data can be read from these registers.

| Address | Register |
| :--- | :--- |
| $0 \times 00$ | Product_ID |
| $0 \times 01$ | Revision_ID |
| $0 \times 02$ | Motion |
| $0 \times 03$ | Delta_X |
| $0 \times 04$ | Delta_Y |
| $0 \times 05$ | SQUAL |
| $0 \times 06$ | Average_Pixel |
| $0 \times 07$ | Maximum_Pixel |
| $0 \times 08$ | Reserved |
| $0 \times 09$ | Reseved |
| $0 \times 0 \mathrm{Ca}$ | Configuration_bits |
| $0 \times 0 b$ | Reserved |


| Address | Register |
| :--- | :--- |
| $0 \times 0 \mathrm{c}$ | Data_Out_Lower |
| $\mathbf{0 x 0 d}$ | Data_Out_Upper |
| $\mathbf{0 x 0 e}$ | Shutter_Lower |
| $\mathbf{0 x 0 f}$ | Shutter_Upper |
| $\mathbf{0 x 1 0}$ | Frame_Period_Lower |
| $\mathbf{0 x 1 1}$ | Frame_Period_Upper |

Product_ID
Access: Read

Address: 0x00
Reset Value: 0x03

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{PID}_{7}$ | $\mathrm{PID}_{6}$ | $\mathrm{PID}_{5}$ | $\mathrm{PID}_{4}$ | $\mathrm{PID}_{3}$ | $\mathrm{PID}_{2}$ | $\mathrm{PID}_{1}$ | $\mathrm{PID}_{0}$ |
|  |  |  |  |  |  |  |  |  |

Data Type: Eight bit number with the product identifier.
USAGE: The value in this register does not change; it can be used to verify that the serial communications link is OK.


Data Type: Eight bit number with current revision of the IC.
USAGE : NN is a value between 00 and FF which represent the current design revision of the device.

| IC Revision | NN |
| :---: | :---: |
| Rev. 1.0 | $0 \times 10$ |
| Rev. 2.0 | $0 \times 20$ |


| Motion | Address: $0 \times 02$ |
| :--- | :--- |
| Access: Read | Reset Value: $0 \times 00$ |


| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | MOT | Reserved | FAULT | OVFY | OVFX | Reserved | Reserved | RES |

Data Type: Bit field
USAGE: Register $0 \times 02$ allows the user to determine if motion has occurred since the last time it was read. If so, then the user should read registers $0 x 03$ and $0 x 04$ to get the accumulated motion. It also tells if the motion buffers have overflowed and whether or not an LED fault occurred since the last reading. The current resolution is also shown.

| Field Name | Description |
| :---: | :---: |
| MOT | Motion since last report or PD <br> $0=$ No motion <br> 1 = Motion occurred, data ready for reading in Delta_X and Delta_Y registers |
| Reserved | Reserved for future |
| FAULT | LED Fault detected - set when RBIN is too low or too high, shorts to $\mathrm{V}_{\mathrm{DD}}$ or Ground $0=$ No fault <br> 1 = Fault detected |
| OVFY | Motion overflow $\mathrm{Y}, \Delta \mathrm{Y}$ buffer has overflowed since last report <br> $0=$ No overflow <br> 1 = Overflow has occurred |
| OVFX | Motion overflow $\mathrm{X}, \Delta \mathrm{X}$ buffer has overflowed since last report $0=$ No overflow <br> 1 = Overflow has occurred |
| Reserved |  |
| Reserved | Reserved for future |
| RES | Resolution in counts per inch $\begin{aligned} & 0=400 \\ & 1=800 \end{aligned}$ |

Notes for Motion:

1. Reading this register freezes the Delta_ $X$ and Delta_Y register values. Read this register before reading the Delta_X and Delta_Y registers. If Delta_X and Delta_Y are not read before the motion register is read a second time, the data in Delta_X and Delta_Y will be lost.
2. Agilent RECOMMENDS that registers $0 \times 02$, $0 \times 03$ and $0 \times 04$ be read sequentially.
3. Internal buffers can accumulate more than eight bits of motion for X or Y . If either one of the internal buffers overflows, then absolute
path data is lost, and the OVFX or OVFY bit is set. To clear these bits (OVFX and OVFY), read the Motion, Delta_X and Delta_Y registers consecutively. Repeat until the motion bit (MOT) is cleared. Until MOT is cleared, the Delta_X or Delta_Y registers will read either positive or negative full scale, except possibly the last read. If the motion register has not been read for long time, at 400 cpi it may take up to 16 read cycles to clear the buffers, at 800 cpi, up to 32 cycles.
4. The FAULT bit signifies that an LED fault has
occurred since the last time the motion register was read. An LED fault occurs if RBIN has a low resistance connection to ground. When this is detected the LED is turned off. The FAULT bit is set after a fault occurs. The FAULT bit remains set until the fault condition is cleared and the motion register is read. This bit is updated only when the motion register is read. Once an LED fault has cleared, the hardware will drive the LED normally.

Delta_X
Access: Read

Address: 0x03
Reset Value: 0x00

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | $\mathrm{x}_{7}$ | $\mathrm{x}_{6}$ | $\mathrm{x}_{5}$ | $\mathrm{x}_{4}$ | $\mathrm{x}_{3}$ | $\mathrm{x}_{2}$ | $\mathrm{x}_{1}$ | $\mathrm{x}_{0}$ |
|  |  |  |  |  |  |  |  |  |

Data Type: Eight bit 2's complement number.
USAGE: X movement is counts since last report. Absolute value is determined by resolution. Reading clears the register.


Data Type: Eight bit 2's complement number.
USAGE: Y movement is counts since last report. Absolute value is determined by resolution. Reading clears the register


SOUAL
Access: Read

Address: 0x05
Reset Value: 0x00

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | $\mathrm{SO}_{7}$ | $\mathrm{SO}_{6}$ | $\mathrm{SO}_{5}$ | $\mathrm{SO}_{4}$ | $\mathrm{SO}_{3}$ | $\mathrm{SO}_{2}$ | $\mathrm{SO}_{1}$ | $\mathrm{SO}_{0}$ |

Data Type: Eight bit number.
USAGE: SQUAL (Surface QUALity) is a measure of the number of features visible by the sensor in the current frame. The maximum value is 255 .
Since small changes in the current frame can result in changes in SQUAL, variations in SQUAL when looking at a surface are expected. The graph below shows 250 sequentially acquired SQUAL values, while a sensor was moved slowly over white paper. SQUAL is nearly equal to zero, if there is no surface below the sensor.


The focus point is important and could affect the SQUAL value. Figure 37 shows another setup with various Zheight. This graph clearly shows that the SQUAL count is dependent on focus distance. The data is obtained by getting multiple readings over different heights.


Figure 37. Typical SOUAL vs. Height, Z . (white paper)

Average_Pixel
Access: Read

Address: 0x06
Reset Value: 0x00

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | 0 | 0 | $\mathrm{AP}_{5}$ | $\mathrm{AP}_{4}$ | $\mathrm{AP}_{3}$ | $\mathrm{AP}_{2}$ | $\mathrm{AP}_{1}$ | $\mathrm{AP}_{0}$ |

Data Type: Six bit number.
USAGE: Average Pixel value in current frame. Minimum value $=0$, maximum $=63$. The average pixel value may vary from frame to frame. Shown below is a graph of $\mathbf{2 5 0}$ sequentially acquired average pixel values, while the sensor was moved slowly over white paper.

## Average Pixel (White Paper)



Maximum_Pixel
Access: Read

Address: 0x07
Reset Value: 0x00

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | 0 | 0 | $\mathrm{MP}_{5}$ | $\mathrm{MP}_{4}$ | $\mathrm{MP}_{3}$ | $\mathrm{MP}_{2}$ | $\mathrm{MP}_{1}$ | $\mathrm{MP}_{0}$ |
|  |  |  |  |  |  |  |  |  |

Data Type: Six bit number.
USAGE: Maximum Pixel value in current frame. Minimum value $=0$, maximum value $=63$. The maximum pixel value may vary from frame to frame. Shown below is a graph of $\mathbf{2 5 0}$ sequentially acquired maximum pixel values, while the sensor was moved slowly over white paper.


| Reserved |  |  | Address: 0x08 |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reserved |  |  | Address: 0x09 |  |  |  |  |  |
| Configuration_bits Access: Read/Write |  |  | Address: 0x0a <br> Reset Value: 0x00 |  |  |  |  |  |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Field | RESET | LED_MODE | Self Test | RES | PixDump | Reserved | Reserved | Sleep |

Data Type: Bit field
USAGE: Register 0x0a allows the user to change the configuration of the sensor. Shown below are the bits, their default values, and optional values.

| Field Name | Description |
| :---: | :---: |
| RESET | Power up defaults (bit always reads 0 ) <br> $0=$ No effect <br> 1 = Reset registers and bits to power up default settings (bold entries) |
| LED_MODE | LED Shutter Mode <br> $0=$ Shutter mode off (LED always on, even if no motion up to 1 sec ) <br> 1 = Shutter mode on (LED only on when electronic shutter is open) |
| Self Test ${ }^{[1]}$ | Self Tests (bit always reads 0) <br> $0=$ No tests <br> 1 = Perform all self tests, output 16 bit CRC via Data_Out_Upper and Data_Out_Lower registers. |
| RES | Resolution in counts per inch $\begin{aligned} & 0=400 \\ & 1=800 \end{aligned}$ |
| Pix Dump | Dump the pixel array through Data_Out_Upper and Data_Out_Lower, 256 bytes each $0=$ Disabled <br> 1 = Dump pixel array |
| Reserved |  |
| Reserved |  |
| Sleep | Sleep Mode <br> $0=$ Normal, falls asleep after one second of no movement (1,500 frames/s) <br> 1 = Always awake |

## Note:

1. Since part of the self test is a RAM test, the RAM will be overwritten with the default values when the test is done. If any configuration changes from the default are needed for operation, make the changes AFTER the self test is run. This operation requires substantially more time to complete than other register transactions.

| Reserved | Address: 0x0b |
| :--- | :--- |
| Data_Out_Lower | Address: 0x0c |
| Access: Read | Reset Value: undefined |


| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | DO7 | D0 ${ }_{6}$ | DO5 | DO4 | DO3 | $\mathrm{DO}_{2}$ | D01 | DO |

Data_Out_Upper
Access: Read

Address: 0x0d
Reset Value: undefined

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | D0 ${ }_{15}$ | D ${ }_{14}$ | D0 ${ }_{13}$ | D0 ${ }_{12}$ | D0 ${ }_{11}$ | D0 $\mathbf{1 0}$ | DO9 | D088 |

Data Type: Sixteen bit word.
USAGE: Data from the system self test or the pixel dump command can be read out with these registers. The data can be read from $0 x 0 \mathrm{~d}$ only, or from $0 \times 0 d$ followed by $0 \times 0 \mathrm{c}$.

|  | Data_Out_Upper | Data_Out_Lower | Notes |
| ---: | :--- | :--- | :--- |
| Self Test result 1: | DB | FD | One of two results returned. <br> These values are subject to change <br> with each device design revision. |
| Pixel Dump command: | Pixel Address | D6 | Pixel Data (bits 0-5) and |
|  |  | Pixel Data Status (bit 7) |  |

Once the pixel dump command is given, the sensor writes the address and the value for the first pixel into the Data_Out_Upper and Data_Out_Lower registers. The MSB of Data_Out_Lower is the status bit for the data. If the bit is high, the data are NOT valid. Once the MSB is low, the data for that particular read are valid and should be saved. The pixel address and data will then be incremented on the next frame. Once the pixel dump is complete, the PixDump bit in register 0x0a should be set to zero. To obtain an accurate image to get the Pixel Dump image, the LED needs to be turned on by changing the sleep mode of the configuration register $0 \times 0$ a to always awake.

## Pixel Address Map (looking through the HDNS-2100 lens)

Last Pixel


Top X-ray View of Mouse


Figure 38. Directions are for a complete mouse, with the HDNS-2100 lens.

## Pixel Dump Pictures

The following images are the output of the pixel dump command. The data ranges from zero for complete black,
to 63 for complete white. An internal AGC circuit adjusts the shutter value to keep the brightest feature (max pixel) in the mid 50's.

(a) White Paper

(c) Neoprene Mouse Pad (Gray)

(b) Manila Folder

(d) USAF Test Chart Group 3, Element 1, 8 line pairs per mm

Figure 39. Pixel dump pictures.

| Shutter_Lower | Address: 0x0e |
| :--- | :--- |
| Access: Read | Reset Value: 0x64 |


| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | $\mathrm{S}_{7}$ | $\mathrm{S}_{6}$ | $\mathrm{S}_{5}$ | $\mathrm{S}_{4}$ | $\mathrm{S}_{3}$ | $\mathrm{S}_{2}$ | $\mathrm{S}_{1}$ | $\mathrm{S}_{0}$ |

Shutter_Upper
Access: Read

Address: 0x0f
Reset Value: 0x00

| Biteld | $\mathbf{7}$ | $\mathbf{6}$ | $\mathbf{5}$ | $\mathbf{4}$ | $\mathbf{3}$ | $\mathbf{2}$ | $\mathbf{1}$ | $\mathbf{0}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{S}_{15}$ | $\mathrm{~S}_{14}$ | $\mathrm{~S}_{13}$ | $\mathrm{~S}_{12}$ | $\mathrm{~S}_{11}$ | $\mathrm{~S}_{10}$ | $\mathrm{~S}_{9}$ | $\mathrm{~S}_{8}$ |
|  |  |  |  |  |  |  |  |  |

Data Type: Sixteen bit word.
USAGE: Units are clock cycles; default value is 64 . Read Shutter_Upper first, then Shutter_Lower. They should be read consecutively. The shutter is adjusted to keep the average and maximum pixel values within normal operating ranges. The shutter value may be different on every frame. For each frame, the shutter can only change by $\pm \mathbf{1 / 1 6}$ of the current value. Shown below is a graph of $\mathbf{2 5 0}$ sequentially acquired shutter values, while the sensor was moved slowly over white paper.


The focus point is important and could affect the shutter value. Figure 40 shows another setup with various Zheights. This graph clearly shows that the shutter value is dependent on focus distance. It shows average readings over different heights.


Figure 40. Typical shutter vs. Z (white paper).

The maximum value of the shutter is dependent upon the frame rate and clock frequency. The formula for the maximum shutter value is:

Max shutter value
$=\frac{\text { clock freq }}{\text { frame rate }}-2816$

For a clock frequency of 18 MHz , the following table shows the maximum shutter value. 1 clock cycle is 55.56 nsec .

| Frames/second | Max Shutter |  | Shutter |  |
| :--- | :--- | :--- | :--- | :--- |
|  | Decimal | Hex | Upper | Lower |
| $2300^{*}$ | 5010 | $0 \times 1392$ | 13 | 92 |
| $2000^{*}$ | 6184 | $0 \times 1828$ | 18 | 28 |
| 1500 | 9184 | $0 \times 23 E 0$ | 23 | E0 |
| 1000 | 15184 | $0 \times 3 B 50$ | $3 B$ | 50 |
| 500 | 33184 | $0 \times 81$ A0 | 81 | A0 |

* Note: To optimize tracking performance on dark surfaces, it is recommended that an adaptive frame rate based on shutter value be implemented for frame rates greater than 1500.

Frame_Period_Lower
Access: Read/Write

Address: 0x10
Reset Value: 0x20

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | $\mathrm{FP}_{7}$ | $\mathrm{FP}_{6}$ | FP ${ }_{5}$ | $\mathrm{FP}_{4}$ | $\mathrm{FP}_{3}$ | $\mathrm{FP}_{2}$ | FP ${ }_{1}$ | $\mathrm{FP}_{0}$ |

Frame_Period_Upper
Access: Read/Write

Address: 0x11
Reset Value: 0xd1

| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Field | $\mathrm{FP}_{15}$ | $\mathrm{FP}_{14}$ | $\mathrm{FP}_{13}$ | $\mathrm{FP}_{12}$ | $\mathrm{FP}_{11}$ | $\mathrm{FP}_{10}$ | FP9 | $\mathrm{FP}_{8}$ |

Data Type: Sixteen bit 2's complement word.
USAGE: Sets the frame rate. The frame period counter counts up until it overflows. Units are clock cycles.
The formula is: clock rate For an 18 MHz clock, below
= counts frame rate are the Frame_period values
(2's complements hex) for popular frame rates.

| Frames/second | Counts |  |  | Frame_Period |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Decimal | Hex | 2's comp | Upper | Lower |  |
| 2300* | 7826 | 0x1E92 | 0xE16E | E1 | 6 E |  |
| 2000* | 9000 | 0x2328 | 0xDCD8 | DC | D8 |  |
| 1500 | 12000 | 0x2EE0 | 0xD120 | D1 | 20 | $\leftarrow$ Default Frame Period |
| 1000 | 18000 | 0x4650 | 0xB9B0 | B9 | B0 |  |
| 500 | 36000 | 0x8CA0 | 0x7360 | 73 | 60 | $\leftarrow$ Minimum Frame Period |

*Note: To optimize tracking performance on dark surfaces, it is recommended that an adaptive frame rate based on shutter value be implemented for frame rates greater than 1500.

Changing the frame rate results
in changes in the maximum
speed, acceleration limits, and
dark surface performance.

## IC Register State after Reset (power up or setting bit 7, register 0x0a)

| Address | Register | Default Value | Meaning |
| :---: | :---: | :---: | :---: |
| 0x00 | Product_ID | 0x03 | Product ID = 3 (Fixed value) |
| 0x01 | Revision_ID | OxNN | Revision of IC (Fixed value) (For each device design revision) |
| 0x02 | Motion | 0x00 | No Motion LED = No fault <br> No X data overflow <br> No Y data overflow <br> Resolution is $\mathbf{4 0 0}$ counts per inch |
| 0x03 | Delta_X | 0x00 | No X motion |
| 0x04 | Delta_Y | 0x00 | No Y motion |
| 0x05 | SOUAL | 0x00 | No image yet to measure |
| $0 \times 06$ | Average_Pixel | 0x00 | No image yet to measure |
| 0x07 | Maximum_Pixel | 0x00 | No image yet to measure |
| 0x08 | Reserved |  |  |
| $0 \times 09$ | Reserved |  |  |
| 0x0a | Configuration_bits | 0x00 | Part is not Reset LED Shutter Mode is off No Self Tests Resolution $=\mathbf{4 0 0}$ counts per inch Pixel Dump is disabled Sleep mode is enabled |
| 0x0b | Reserved | - |  |
| 0x0c | Data_Out_Lower | undefined | No data to read |
| 0x0d | Data_Out_Upper | undefined | No data to read |
| 0x0e | Shutter_Lower | 0x64 | Initial shutter value |
| 0xOf | Shutter_Upper | 0x00 | Initial shutter value |
| 0x10 | Frame_Period_Lower | 0x20 | Initial frame period value (corresponds to 1500 fps ) |
| $0 \times 11$ | Frame_Period_Upper | 0xd1 | Initial frame period value (corresponds to 1500 fps ) |

# Optical Mouse Design References 

Application Note AN1179
Eye Safety Calculation AN1228

## Ordering Information

Specify part number as follows:
ADNS-2030 $=$ Sensor IC in a 16 -pin staggered DIP, 20 per tube.
HDNS-2100 = Round Optical Mouse Lens
HDNS-2100\#001 = Trimmed Optical Mouse Lens
HDNS-2200 = LED Assembly Clip (Black)
HDNS-2200\#001 = LED Assembly Clip (Clear)
HLMP-ED80-xx000 = LED

www.agilent.com/<br>semiconductors<br>For product information and a complete list of distributors, please go to our web site.<br>For technical assistance call:<br>Americas/Canada: +1 (800) 235-0312 or<br>(916) 788-6763<br>Europe: +49 (0) 644192460<br>China: 108006500017<br>Hong Kong: (65) 67562394<br>India, Australia, New Zealand: (65) 67551939<br>Japan: (+81 3) 3335-8152(Domestic/International), or 0120-61-1280(Domestic Only)<br>Korea: (65) 67551989<br>Singapore, Malaysia, Vietnam, Thailand,<br>Philippines, Indonesia: (65) 67552044<br>Taiwan: (65) 67551843<br>Data subject to change.<br>Copyright © 2005 Agilent Technologies, Inc.<br>Obsoletes 5988-5686EN<br>May 11, 2005<br>5988-8421EN

